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Patent and Trademark Office

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
 (1) Kuo-Yung CHANG
 Additional name(s) of conveying parties attached? YES NO

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____
 Execution Date: April 12, 2001

2. Name and address of receiving parties:
 Name: Winbond Electronics Corp.
 Internal Address: _____
 Street Address: No. 4, Creation Rd. III, Science-Based Industrial Park, Hsinchu
 City: _____ State: _____
 Zip: _____ Country: Taiwan, R.O.C.
 Additional name(s) & address(es) attached? YES NO



09847024

4. Application number(s) or patent number(s):
 If this document is being filed together with a new application, the execution date of the application is:
 April 12, 2001

A. Patent Application No(s):
 B. Patent No(s):

Additional numbers attached? YES NO

5. Name and address of party to whom correspondence concerning document should be mailed:
 Richard P. Berg
 Name: LADAS & PARRY
 Internal Address: _____
 Street Address: 5670 Wilshire Boulevard, #2100
 City: Los Angeles State: CA Zip: 90036-5679

6. Total number of application and patents involved: [1]
 7. Total fee 937 CFR 3.41).....\$ 40.00
 Enclosed
 Any additional fees which may be required are
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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard P. Berg
 Name of Person Signing
 Reg. No. 28,145

Signature

May 1, 2001
 Date

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PATENT
REEL: 011776 FRAME: 0597

ASSIGNMENT

WHEREAS, Kou-Yung CHANG
hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements
as described and set forth in the below identified application for United States Letters Patent:

Title: METHOD AND SYSTEM FOR SEMICONDUCTOR DIE TESTING

Filed: _____ Serial No. _____

Executed on: April 12, 2001

WHEREAS, Winbond Electronics Corp. of No. 4, Creation Rd. III, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.
hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the
said invention and application and in any U.S. Letters Patent which may be granted on the
same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for
good and valuable consideration, receipt of which is hereby acknowledged by Assignor,
Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign
and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their
rights, title and interest in and to the said invention and application and all future
improvements thereon, and in and to any Letters Patent which may hereafter be granted on the
same in the United States, the said interest to be held and enjoyed by said Assignee as fully and
exclusively as it would have been held and enjoyed by said Assignor had this Assignment and
transfer not been made, to the full end and term of any Letters Patent which may be granted
thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion,
reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said
Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said
application and/or applications, execute, verify, acknowledge and deliver all such further
papers, including applications for Letters Patent and for the reissue thereof, and instruments of
assignment and transfer thereof, and will perform such other acts as Assignee lawfully may
request, to obtain or maintain Letters Patent for said invention and improvement, and to vest
title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the
date(s) indicated.

✓ Kou-Yung Chang
Kou-Yung CHANG

901/4/12
Date: